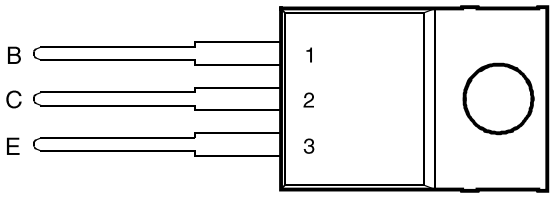
TRANSYS ELECTRONICS LIMITED

TIP150, TIP151, TIP152
NPN SILICON POWER DARLINGTONS

- **80 W at 25˚C Case Temperature**
- **7 A Continuous Collector Current**
- **10 A Peak Collector Current**
- **Maximum $V_{CE(sat)}$ of 2 V at I_C = 5 A**
- **$I_{CEX(sus)}$ 7 A at rated $V_{(BR)CEO}$**

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

absolute maximum ratings **at 25˚C case temperature (unless otherwise noted)**

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage (I_E = 0)	TIP150 TIP151 TIP152	V_{CBO}	300 350 400	V
Collector-emitter voltage (I_B = 0)	TIP150 TIP151 TIP152	V_{CEO}	300 350 400	V
Emitter-base voltage		V_{EBO}	8	V
Continuous collector current		I_C	7	A
Peak collector current (see Note 1)		I_{CM}	10	A
Continuous base current		I_B	1.5	A
Continuous device dissipation at (or below) 25˚C case temperature (see Note 2)		P_{tot}	80	W
Continuous device dissipation at (or below) 25˚C free air temperature (see Note 3)		P_{tot}	2	W
Operating junction temperature range		T_j	-65 to +150	˚C
Storage temperature range		T_{stg}	-65 to +150	˚C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	˚C

NOTES: 1. This value applies for $t_p \leq 5$ ms, duty cycle $\leq 10\%$.
2. Derate linearly to 150˚C case temperature at the rate of 0.64 W/˚C.
3. Derate linearly to 150˚C free air temperature at the rate of 16 mW/˚C.

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CBO}$	Collector-base breakdown voltage	I_C = 1 mA	I_E = 0	TIP150	300			V
				TIP151	350			
				TIP152	400			
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	I_C = 10 mA (see Note 4)	I_B = 0	TIP150	300			V
				TIP151	350			
				TIP152	400			
I_{CEO}	Collector-emitter cut-off current	V_{CE} = 300 V	I_B = 0	TIP150			250	µA
		V_{CE} = 350 V	I_B = 0	TIP151			250	
		V_{CE} = 400 V	I_B = 0	TIP152			250	
$I_{CEX(sus)}$	Collector-emitter sustaining current	$V_{CLAMP} = V_{(BR)CEO}$			7			A
I_{EBO}	Emitter cut-off current	V_{EB} = 8 V	I_C = 0				15	mA
h_{FE}	Forward current transfer ratio	V_{CE} = 5 V	I_C = 2.5 A		150			
		V_{CE} = 5 V	I_C = 5 A	(see Notes 4 and 5)	50			
		V_{CE} = 5 V	I_C = 7 A		15			
$V_{CE(sat)}$	Collector-emitter saturation voltage	I_B = 10 mA	I_C = 1 A				1.5	V
		I_B = 100 mA	I_C = 2 A	(see Notes 4 and 5)			1.5	
		I_B = 250 mA	I_C = 5 A				2	
$V_{BE(sat)}$	Base-emitter saturation voltage	I_B = 100 mA	I_C = 2 A	(see Notes 4 and 5)			2.2	V
		I_B = 250 mA	I_C = 5 A				2.3	
V_{EC}	Parallel diode forward voltage	I_E = 7 A	I_B = 0	(see Notes 4 and 5)			3.5	V
h_{fe}	Small signal forward current transfer ratio	V_{CE} = 5 V	I_C = 0.5 A	f = 1 kHz	200			
$\|h_{fe}\|$	Small signal forward current transfer ratio	V_{CE} = 5 V	I_C = 0.5 A	f = 1 MHz	10			
C_{ob}	Output capacitance	V_{CB} = 10 V	I_E = 0	f = 1 MHz			100	pF

NOTES: 4. These parameters must be measured using pulse techniques, t_p = 300 µs, duty cycle ≤ 2%.
5. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.56	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W
$C_{\theta C}$	Thermal capacitance of case		0.9		J/°C

inductive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{sv}	Voltage storage time	I_C = 5 A $V_{(clamp)} = V_{(BR)CEO}$	$I_{B(on)}$ = 250 mA	R_{BE} = 47 Ω		3.9		µs
t_{si}	Current storage time					4.7		µs
t_{rv}	Voltage transition time					1.2		µs
t_{ti}	Current transition time					1.2		µs
t_{xo}	Cross-over time					2.0		µs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

PARAMETER MEASUREMENT INFORMATION

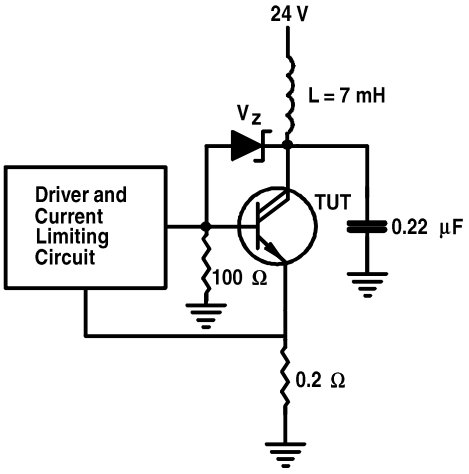


Figure 1. Functional Test Circui t

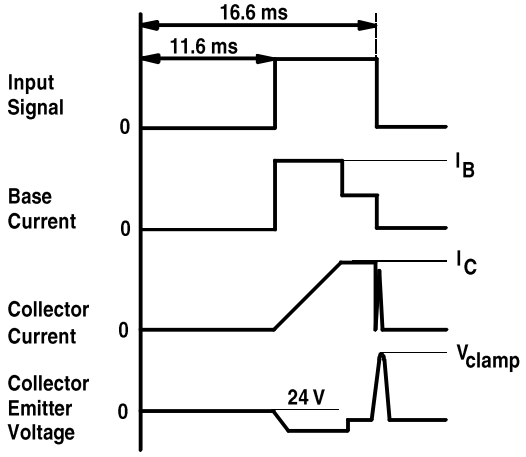


Figure 2. Functional Test Waveform s

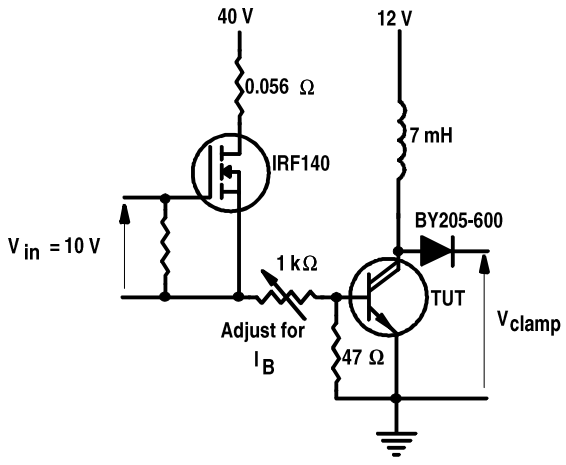


Figure 3. Switching Test Circuit

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

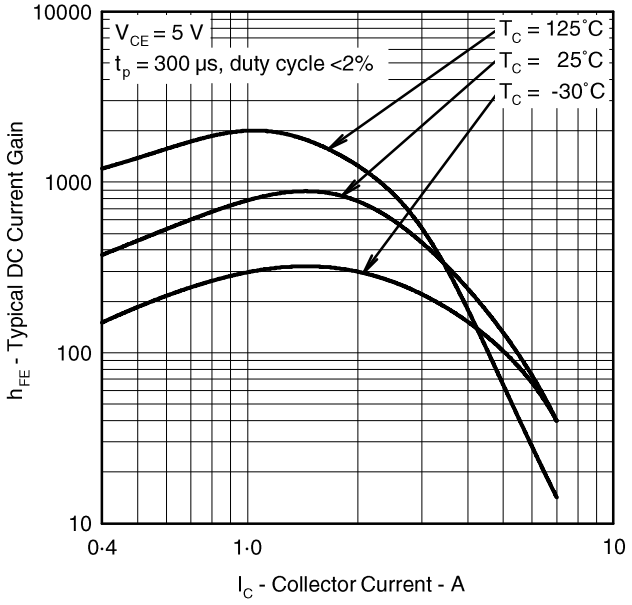


Figure 4.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
COLLECTOR CURRENT

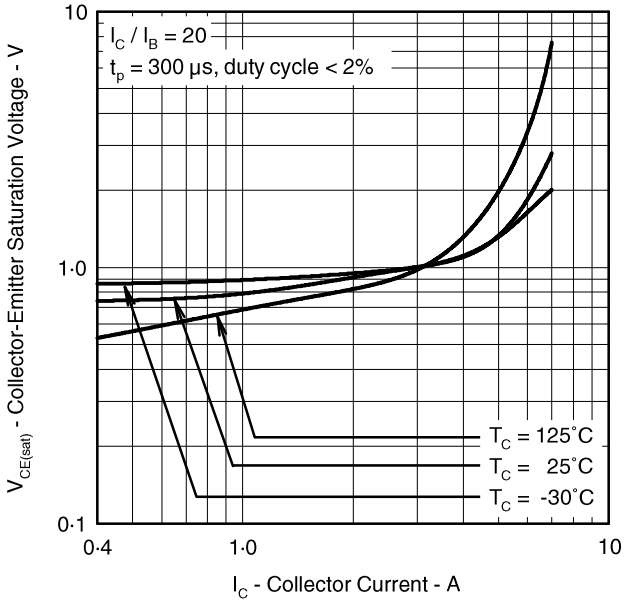


Figure 5.

BASE-EMITTER SATURATION VOLTAGE
vs
COLLECTOR CURRENT

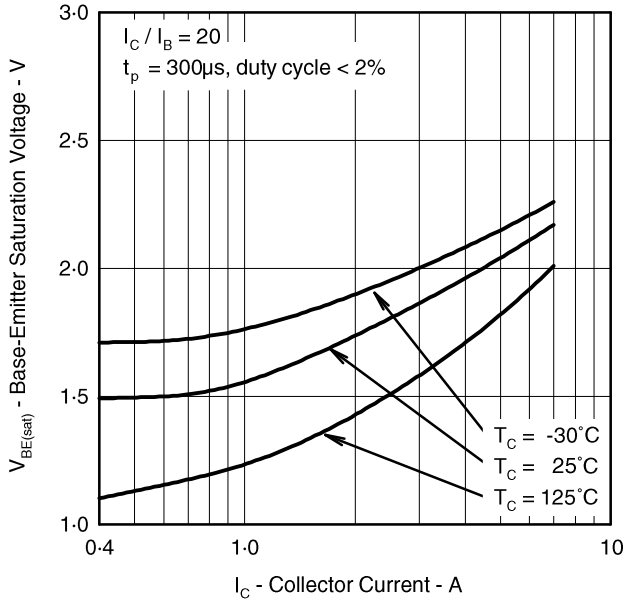


Figure 6.

COLLECTOR CUT-OFF CURRENT
vs
CASE TEMPERATURE

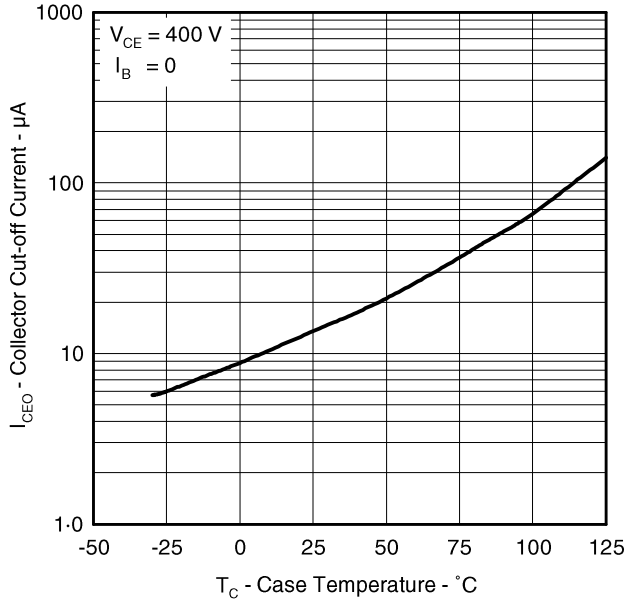


Figure 7.

MAXIMUM SAFE OPERATING REGIONS

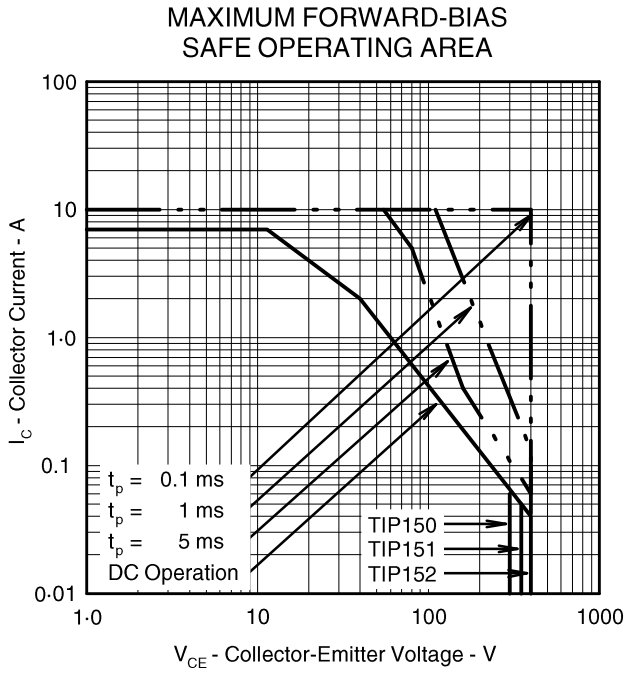


Figure 8.

THERMAL INFORMATION

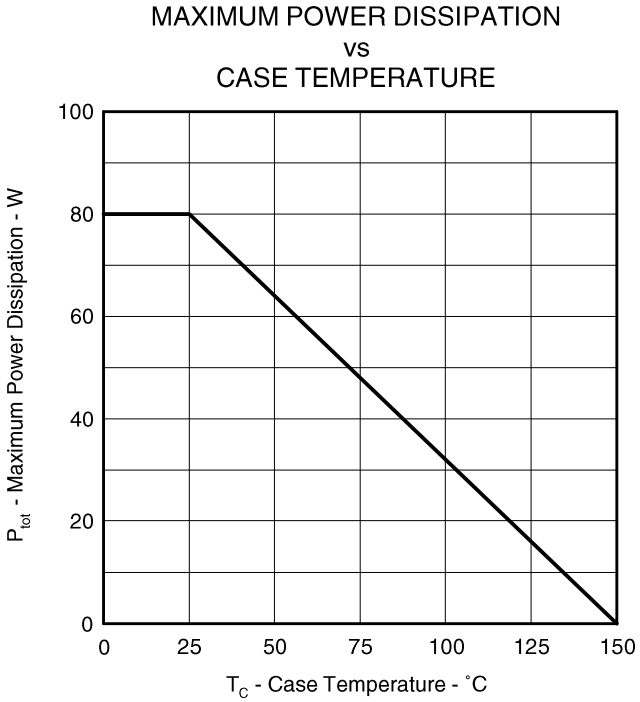


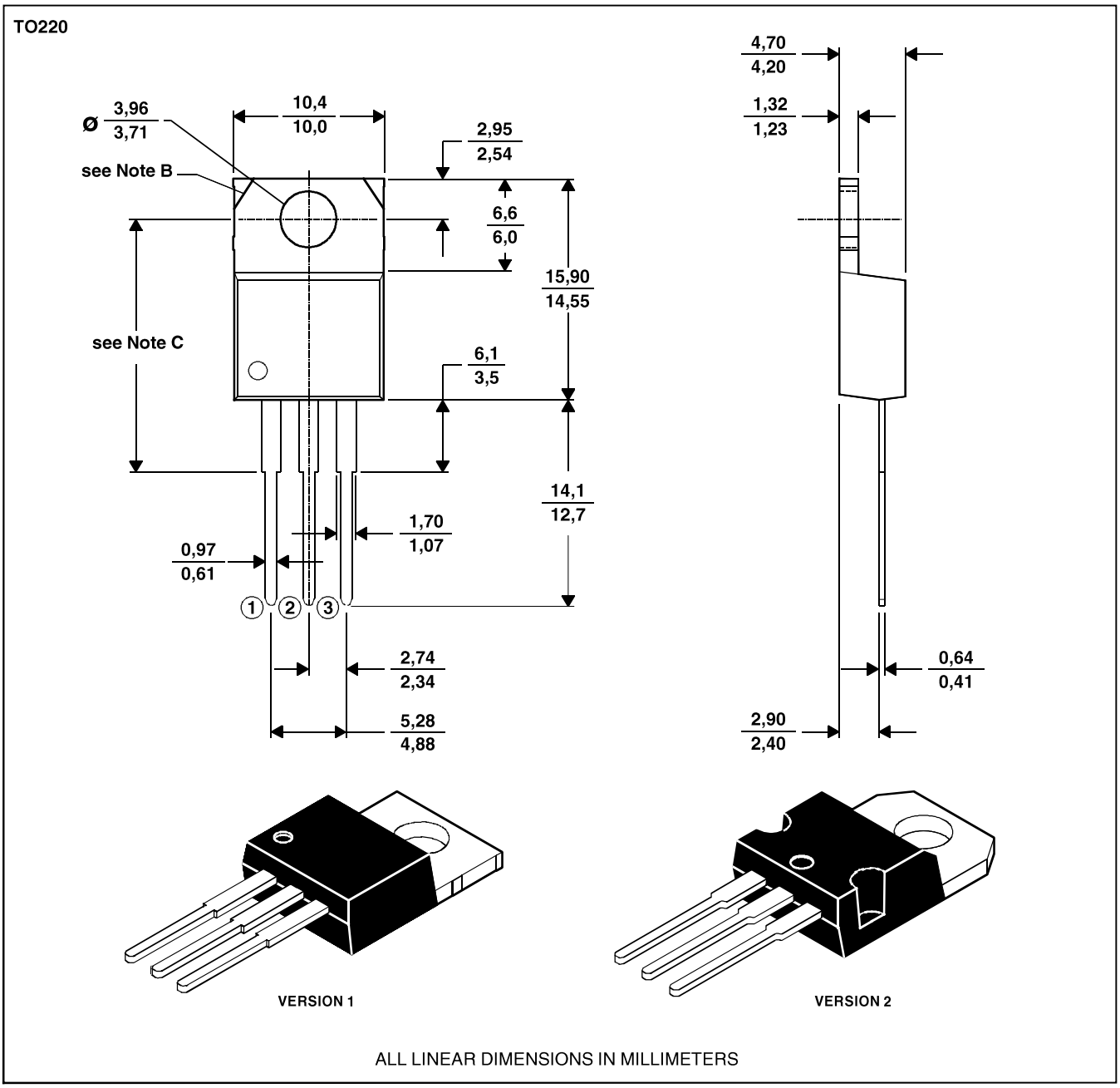
Figure 9.

MECHANICAL DATA

TO-220

3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



NOTES: A. The centre pin is in electrical contact with the mounting tab.
B. Mounting tab corner profile according to package version.
C. Typical fixing hole centre stand off height according to package version.
Version 1, 18.0 mm. Version 2, 17.6 mm.